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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: NAKAMURA, et al.
Serial No.: 10/500,119
Filed: June 17, 2005
For: CONNECTION BOARD, AND MULTI-LAYER WIRING BOARD,
SUBSTRATE FOR SEMICONDUCTOR PACKAGE AND
SEMICONDUCTOR PACKAGE USING CONNECTION
BOARD, AND MANUFACTURING METHOD THEREOF
Group AU: 2841
Examiner: I. Patel
Confirm. No: 7910

PETITION FOR EXTENSION OF TIME

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

January 17, 2007


Sir:

In the matter of the above-identified application, applicants hereby respectfully petition for an extension of time to permit filing a response within the first month subsequent to expiration of the shortened statutory period set in the outstanding Office Action mailed November 20, 2006. A Credit Card Payment Form in the amount of \$120.00 to cover the required fee for the requested extension of time is attached hereto.

It is respectfully requested that any shortage in the fee be charged to the account of Antonelli, Terry, Stout & Kraus, LLP, Account No. 01-2135 (Case No. 1204.43988X00).

Respectfully submitted,

ANTONELLI, TERRY, STOUT & KRAUS, LLP


William I. Solomon
Registration No. 28,565

WIS/slk
Enclosures